

Silicon NPN Planar RF Transistor

Features

- Low noise figure
- High transition frequency $f_T = 7.5$ GHz
- Excellent large signal behaviour
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Applications

For low noise, low distortion broadband amplifiers in telecommunications and antenna systems and power amplifiers

for DECT and PCN systems at collector currents between 20 mA and 80 mA up to 2 GHz



Electrostatic sensitive device.
Observe precautions for handling.

Mechanical Data

Typ: BFP196T

Case: SOT-143 Plastic case

Weight: approx. 8.0 mg

Pinning:

1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Typ: BFP196TR

Case: SOT-143R Plastic case

Weight: approx. 8.0 mg

Pinning:

1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Typ: BFP196TW

Case: SOT-343 Plastic case

Weight: approx. 6.0 mg

Pinning:

1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Parts Table

| Part | Marking | Package |
|----------|---------|----------|
| BFP196T | 196 | SOT-143 |
| BFP196TR | R96 | SOT-143R |
| BFP196TW | W96 | SOT-343 |

Absolute Maximum Ratings

$T_{amb} = 25\text{ °C}$, unless otherwise specified

| Parameter | Test condition | Symbol | Value | Unit |
|---------------------------|-----------------------------|-----------|---------------|------|
| Collector-base voltage | | V_{CBO} | 20 | V |
| Collector-emitter voltage | | V_{CEO} | 12 | V |
| Emitter-base voltage | | V_{EBO} | 2 | V |
| Collector current | | I_C | 100 | mA |
| Total power dissipation | $T_{amb} \leq 60\text{ °C}$ | P_{tot} | 500 | mW |
| Junction temperature | | T_J | 150 | °C |
| Storage temperature range | | T_{stg} | - 65 to + 150 | °C |

Maximum Thermal Resistance

| Parameter | Test condition | Symbol | Value | Unit |
|------------------|----------------|------------|-------|------|
| Junction ambient | 1) | R_{thJA} | 180 | K/W |

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 μm Cu

Electrical DC Characteristics

$T_{amb} = 25\text{ °C}$, unless otherwise specified

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|--------------------------------------|---|---------------|-----|------|-----|------|
| Collector-emitter cut-off current | $V_{CE} = 20\text{ V}, V_{BE} = 0$ | I_{CES} | | | 100 | μA |
| Collector-base cut-off current | $V_{CB} = 10\text{ V}, I_E = 0$ | I_{CBO} | | | 100 | nA |
| Emitter-base cut-off current | $V_{EB} = 1\text{ V}, I_C = 0$ | I_{EBO} | | | 1 | μA |
| Collector-emitter breakdown voltage | $I_C = 1\text{ mA}, I_B = 0$ | $V_{(BR)CEO}$ | 12 | | | V |
| Collector-emitter saturation voltage | $I_C = 70\text{ mA}, I_B = 7\text{ mA}$ | V_{CEsat} | | 0.1 | 0.5 | V |
| DC forward current transfer ratio | $V_{CE} = 8\text{ V}, I_C = 50\text{ mA}$ | h_{FE} | 50 | 100 | 150 | |

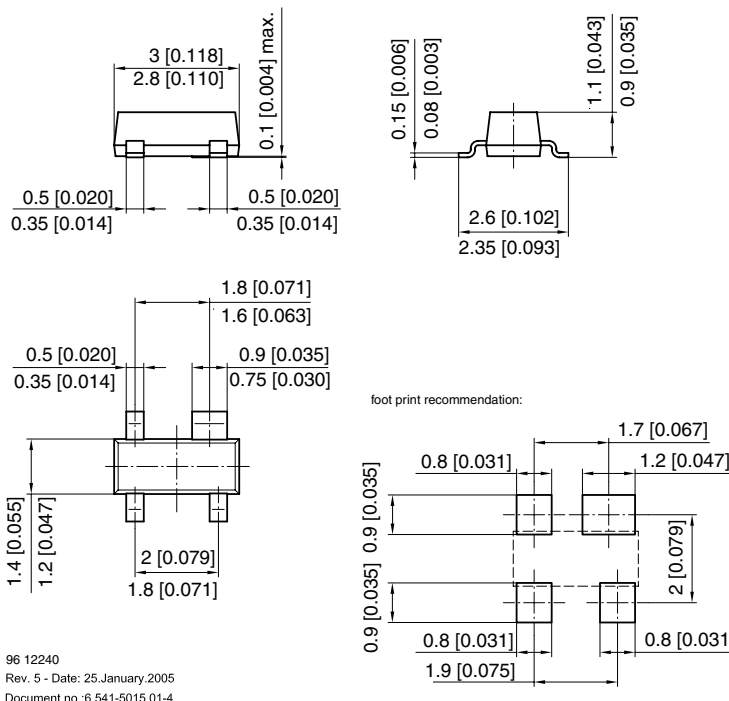


Electrical AC Characteristics

T_{amb} = 25 °C, unless otherwise specified

| Parameter | Test condition | Symbol | Min | Typ. | Max | Unit |
|---------------------------------------|--|---------------------------------|-----|------|-----|------|
| Transition frequency | V _{CE} = 8 V, I _C = 50 mA, f = 1 GHz | f _T | 6 | 7.5 | | GHz |
| Collector-base capacitance | V _{CB} = 10 V, f = 1 MHz | C _{cb} | | 1.0 | 1.4 | pF |
| Collector-emitter capacitance | V _{CE} = 10 V, f = 1 MHz | C _{ce} | | 0.3 | | pF |
| Emitter-base capacitance | V _{EB} = 0.5 V, f = 1 MHz | C _{eb} | | 3.5 | | pF |
| Noise figure | V _{CE} = 8 V, I _C = 20 mA, Z _S = Z _{Sopt} , Z _L = 50 Ω, f = 900 MHz | F | | 1.5 | | dB |
| | V _{CE} = 8 V, I _C = 20 mA, Z _S = Z _{Sopt} , Z _L = 50 Ω, f = 2 GHz | F | | 2.5 | | dB |
| Power gain | V _{CE} = 8 V, I _C = 50 mA, Z _S = Z _{Sopt} , Z _L = 50 Ω, f = 900 MHz | G _{pe} | | 16 | | dB |
| | V _{CE} = 8 V, I _C = 50 mA, Z _S = Z _{Sopt} , Z _L = 50 Ω, f = 2 GHz | G _{pe} | | 10 | | dB |
| Transducer gain | V _{CE} = 8 V, I _C = 50 mA, Z ₀ = 50 Ω, f = 900 MHz | S _{21e} ² | | 12.5 | | dB |
| | V _{CE} = 8 V, I _C = 50 mA, Z ₀ = 50 Ω, f = 2 GHz | S _{21e} ² | | 6.5 | | dB |
| Third order intercept point at output | V _{CE} = 8 V, I _C = 50 mA, f = 900 MHz | IP ₃ | | 36 | | dBm |

Package Dimensions in mm

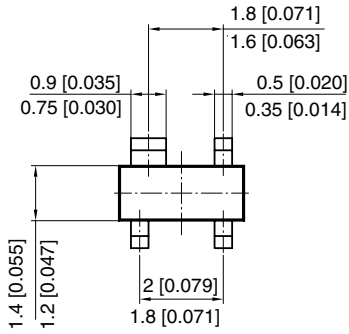
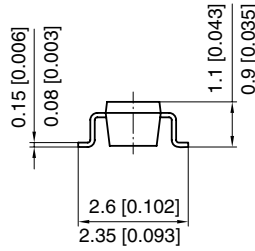
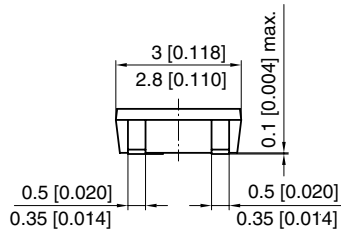


BFP196T / BFP196TR / BFP196TW

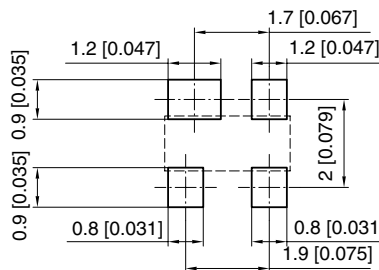


Vishay Semiconductors

Package Dimensions in mm

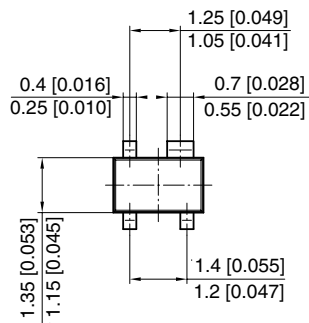
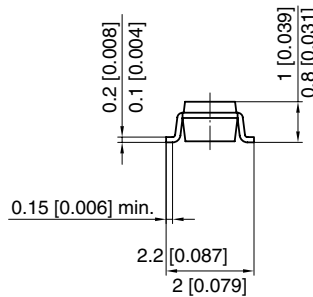
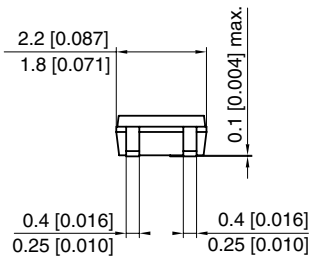


foot print recommendation:

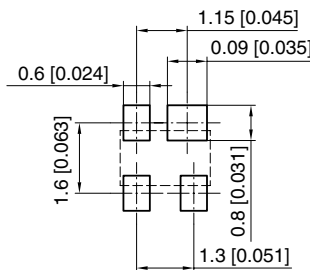


96 12239
Rev. 5 - Date: 25.January.2005
Document no.:6.541-5016.01-4

Package Dimensions in mm



foot print recommendation:



9612237
Rev. 4 - Date: 26.January.2005
Document no.:6.541-5041.01-4



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

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